

# NL3S325FCT2G Datasheet



DiGi Electronics Part Number

NL3S325FCT2G-DG

onsemi

Manufacturer Product Number

Description

Manufacturer

**Detailed Description** 

NL3S325FCT2G

IC AUDIO PROCESSOR 9WLCSP

Audio Audio Processor 2 Channel 9-WLCSP (1.9x1.9

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### Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
NL3S325FCT2G	onsemi
Series:	Product Status:
	Obsolete
Function:	Applications:
Audio Processor	Audio Systems
Number of Channels:	Interface:
2	Analog
Voltage - Supply:	Operating Temperature:
1.6V ~ 3.6V	-40°C ~ 85°C (TA)
Specifications:	Mounting Type:
	Surface Mount
Package / Case:	Supplier Device Package:
9-UFBGA, WLCSP	9-WLCSP (1.9x1.9)
Base Product Number:	
NL3S3	

### **Environmental & Export classification**

Moisture Sensitivity Level (MSL):	REACH Status:
1 (Unlimited)	REACH Unaffected
ECCN:	HTSUS:
EAR99	8542.39.0001

### Audio Jack GND/MIC Configuration Switch

The NL3S325 is an audio jack configuration switch device. It allows reconfiguration of the GND, microphone–bias contact to comply with the American Headset Jack (AHJ) and the Open Mobile Terminal Platform (OMTP) pinout. It also provides a GND sense path that supports quasi–differential audio amplifier architectures.

#### Features

- AHJ and OMTP Headset Jack Pinout Support
- Wide V<sub>DD</sub> Range: 1.6 V to 3.7 V
- Low Supply Current
- Sense Path to GND for Quasi Differential Audio Amplifier Configuration
- Low THD and Noise Microphone Pass-through Channel
- Ultra-low R<sub>ON</sub> of Ground and Sense Switches
- High Power Supply Ripple Rejection
- ESD Performance: 8 kV HBM on SBUn, SENSEn, SENSE, V<sub>DD</sub>, GND 3 kV HBM on MIC, SEL
- Available in 1.19 mm x 1.19 mm WLCSP9
- This Device is Pb–Free, Halogen Free/BFR Free and RoHS Compliant

#### Applications

- Headsets with Integrated MIC and Remote Control Buttons
- USB Type-C Switching



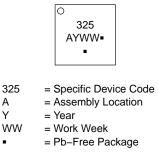
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WLCSP9 FC SUFFIX CASE 567MD

#### MARKING DIAGRAM



(Note: Microdot may be in either location)

#### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
NL3S325FCT2G	WLCSP9 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

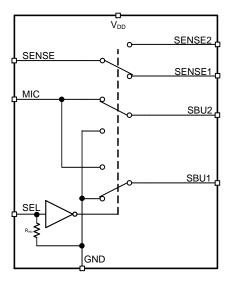


Figure 1. Block Diagram

#### Table 1. FUNCTION TABLE

V <sub>DD</sub>	SEL	Connections	Mode
0 V	Х	All I/O Ports Hi–Z	Disabled
1.6 V to 3.6 V	0	SBU2=MIC; SBU1=GND; SENSE1=SENSE	AHJ
1.6 V to 3.6 V	1	SBU1=MIC; SBU2=GND; SENSE2=SENSE	OMTP

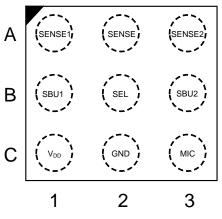
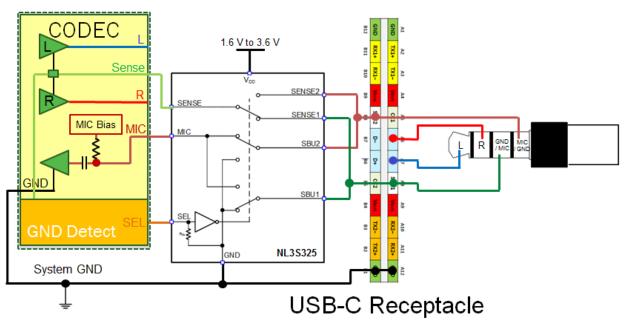


Figure 2. WLCSP9 – Top Through View

#### Table 2. PIN DESCRIPTIONS

Pin Name	Ball	Description
SENSE1	A1	Sense Path 1 to Headset Jack GND
SENSE	A2	Sense Path for GND Sensing
SENSE2	A3	Sense Path 2 to Headset Jack GND
SBU1	B1	USB Type-C SBU1 Connection
SEL	B2	Configuration Select
SBU2	B3	USB Type-C SBU2 Connection
V <sub>DD</sub>	C1	Power Supply
GND	C2	Ground
MIC	C3	MIC Bias Path CODEC Side

NL3S325



The default configuration (SEL = 0) is for AHJ-compliant headsets.

#### Figure 3. Typical Application

NOTE: When V<sub>DD</sub> is not powered, all the FETs become open by default. Thus, the ground return path becomes floating. Noise might be heard if a speaker (with external powered amplifier) is plugged in the audio jack. It is highly recommended when the audio jack detects a plug–in, the NL3S325 is kept powered until unplug.

Symbol	Rating	Value	Unit	
V <sub>DD</sub>	Positive DC Supply Voltage		-0.5 to +4.5	V
V <sub>IS</sub>	Analog Input/Output Voltage		-0.5 to +4.5	V
V <sub>IN</sub>	Digital Control Pin Voltage, SEL		-0.5 to +4.5	V
I <sub>SW(GND)</sub>	Continuous SBU1 or SBU2 to GND Current		100	mA
I <sub>SW(MIC)</sub>	Continuous MIC to SBU1 or SBU2 Current		50	mA
I <sub>SW(SNS)</sub>	Continuous SENSE to SENSE1 or SENSE2 Current		50	mA
Τs	Storage Temperature	–55 to +150	°C	
ΤL	Lead Temperature, 1 mm from Case for 10 seconds		260	°C
TJ	Junction Temperature Under Bias		150	°C
MSL	Moisture Sensitivity (Note 1)		Level 1	
I <sub>LU</sub>	Latchup Current (Note 2)		±100	mA
ESD	ESD Protection (Note 3)			V
	Human Body Model SENSE, SENSEn, SBUn, V <sub>DD</sub>	, GND	8000	
	MIC	C, SEL	3000	
	Machine Model A	ll Pins	200	
	Charged Device Model A	ll Pins	1000	

#### **Table 3. MAXIMUM RATINGS**

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Moisture Sensitivity Level (MSL): 1 per IPC/JEDEC standard: J-STD-020A.

2. Latch up Current Maximum Rating: ±100 mA per JEDEC standard: JESD78.

3. This device series contains ESD protection and passes the following tests:

Human Body Model (HBM) per JEDEC standard: JESD22–A114. Machine Model (MM) per JEDEC standard: JESD22–A115.

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#### Table 4. RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V <sub>DD</sub>	Positive DC Supply Voltage	1.6	3.7	V
V <sub>IS</sub>	Switch Input / Output Voltage	GND	3.6	V
V <sub>IN</sub>	Digital Control Input Voltage	GND	3.6	V
T <sub>A</sub>	Operating Temperature Range	-40	+85	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

#### Table 5. DC ELECTRICAL CHARACTERISTICS (Typical values are at $V_{DD}$ = +3.0 V and $T_A$ = +25°C unless otherwise specified.)

				-4	40°C to 85	°C	
Symbol	Parameter	Test Conditions	V <sub>DD</sub> (V)	Min	Тур	Max	Unit
POWER SU	PPLY						
I <sub>DD</sub>	Supply Current	$T_A = 25^{\circ}C$	3.0	-	0.1	1	μΑ
		T <sub>A</sub> = 85°C	3.0	-	-	5	
CONTROL	LOGIC (SEL)						
V <sub>IH</sub>	Input High Voltage		3.0	1.0	-	-	V
V <sub>IL</sub>	Input Low Voltage		3.0	-	-	0.4	V
R <sub>PD</sub>	Pull-down Resistor		1.6 – 3.6	-	550	-	kΩ
I <sub>OFF</sub>	Power OFF Leakage	V <sub>IN</sub> = 3.6 V	0	-	-	1	μΑ
MIC BIAS S	WITCH (MIC to SBU1 or SBU2)						
R <sub>ON</sub>	ON-Resistance	$V_{IS} = 850 \text{ mV}, I_O = 30 \text{ mA}$	1.8	-	1.6	2.0	Ω
			3.0	-	0.5	0.9	Ω
			3.6	-	0.46	0.8	Ω
R <sub>ON(FLAT)</sub>	ON-Resistance	$V_{\text{IS}}$ = 0.8 V to 1.2 V, $I_{\text{O}}$ = 30 mA	1.8	-	-	0.6	Ω
	Flatness		3.0	-	-	0.2	Ω
			3.6	-	-	0.1	Ω
۱ <sub>S</sub>	Switch Leakage Current	V <sub>MIC</sub> = 850 mV, SBUn Open, SEL = H or L	1.6 to 3.6	-	-	1.5	μΑ
CS	Switch Capacitance	MIC, SBUn Open, SEL = H or L	3.0	-	250	-	pF
THD	Total Harmonic Distortion of Conducting Switch	$ \begin{array}{l} {{R_{S}} = {R_{L}} = 600\;\Omega,{f_{AC}} = 20\;\text{kHz},} \\ {V_{AC}} = 0.5\;{V_{PP}},{V_{DC}} = 1.7\;\text{V},} \\ {SEL} = H \text{ or }L \end{array} $	3.0	-	0.002	_	%
PSRR	Power Supply Rejection Ra- tio of Conducting Switch		3.0	-	-103	-	dB
GND SWITC	CH (SBU1 or SBU2 to GND)						
R <sub>ON</sub> ON–Resistance	ON-Resistance	I <sub>ISBUn</sub> = 100 mA	1.8	-	70	130	mΩ
			3.0	-	60	110	mΩ
			3.6	-	57	105	mΩ
R <sub>ON(FLAT)</sub>	ON-Resistance	I <sub>ISBUn</sub> = 10 mA	1.8 to 3.6	-	-	50	mΩ
	Flatness	I <sub>ISBUn</sub> = 1 mA	1.8 to 3.6	-	-	30	mΩ
PSRR	Power Supply Rejection Ratio of Conducting Switch	$R_{S} = 8 $ Ω, $V_{S} = 1 $ V, $f = 217 $ Hz, $V_{AC} = 0.3 $ V <sub>PP</sub> , SEL = H or L	3.0	_	-88	_	dB

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Table 5. DC ELECTRICAL CHARACTERISTICS (Typical values are at  $V_{DD}$  = +3.0 V and  $T_A$  = +25°C unless otherwise specified.)

				-4	40°C to 85	5°C	
Symbol	Parameter	Test Conditions	V <sub>DD</sub> (V)	Min	Тур	Max	Unit
SENSE SW	ITCH (SENSE to SENSE1 or SE	NSE2)					
R <sub>ON</sub>	ON-Resistance	I <sub>ISENSE</sub> = 30 mA, SENSEn = 0 V	1.8	-	80	130	mΩ
			3.0	-	60	90	
			3.6	-	57	82	
R <sub>ON(FLAT)</sub>	ON-Resistance	I <sub>ISENSE</sub> = 10 mA, SENSEn = 0 V	1.8 to 3.6	-	-	50	mΩ
	Flatness	I <sub>ISENSE</sub> = 1 mA, SENSEn = 0 V	1.8 to 3.6	-	-	40	
۱ <sub>S</sub>	Switch Leakage Current	V <sub>SENSE</sub> = 1 V, SEL = L, SENSE1 Open, SENSE2 = GND	1.6 to 3.6	-	-	1	μΑ
		V <sub>SENSE</sub> = 1 V, SEL = H, SENSE1 = GND, SENSE2 Open				1	]

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

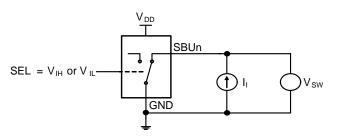
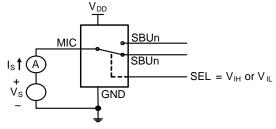


Figure 4. ON Resistance

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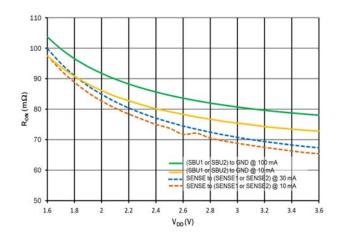
#### **Test Circuit and Graphs**



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Figure 5. Leakage Current





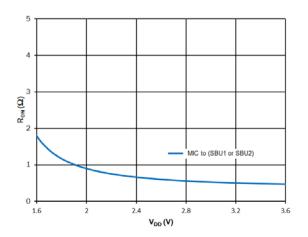
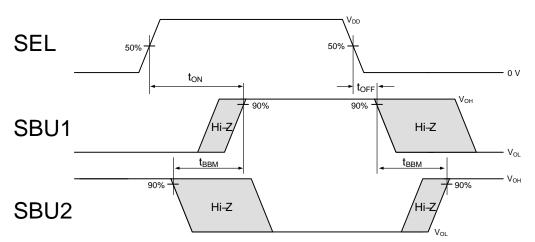


Figure 7. R<sub>ON</sub> (MIC @ I<sub>I</sub> = 30 mA)

			–40°C to 85°C				
Symbol	Parameter	Test Conditions	V <sub>CC</sub> (V)	Min	Тур	Max	Unit
t <sub>ON</sub>	Turn–On Time		3.0	-	215	400	ns
toff	Turn–Off Time		3.0	-	80	140	ns
t <sub>BBM</sub>	Break-before-make Time		3.0	70 (Note 4)	100	320	ns

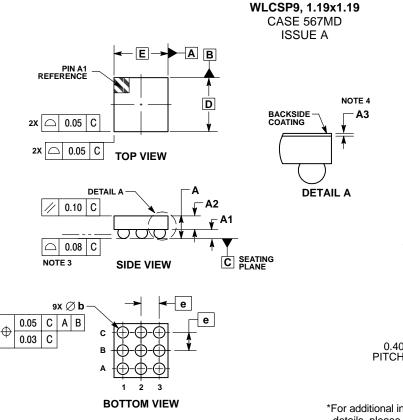
Table 6. AC ELECTRICAL CHARACTERISTICS (Typical values are at  $V_{DD}$  = +3.0 V and  $T_A$  = +25°C, unless otherwise specified.)

4. Guaranteed by design.





#### PACKAGE DIMENSIONS



NOTES: 1. DIMENSIONING AND TOLERANCING PER

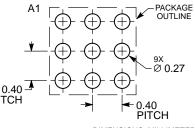
ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: MILLIMETERS.

3. COPLANARITY APPLIES TO THE SPHERICAL

CROWNS OF THE SOLDER BALLS. 4. BACKSIDE COATING IS OPTIONAL.

. DACK	SIDE COATING 13				
	MILLIN	IETERS			
DIM	MIN	MAX			
Α		0.52			
A1	0.18	0.22			
A2	0.26	0.29			
A3	0.000	0.027			
b	0.24	0.28			
D	1.19 BSC				
E	1.19 BSC				
е	0.40	BSC			

#### RECOMMENDED SOLDERING FOOTPRINT\*



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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